INTEGRATED CIRCUITS

DATA SHEET

SA3603 Cellular-band low voltage front-end

Preliminary specification

1999 Dec 17

IC17 Data Handbook





Cellular-band low voltage front-end

SA3603

DESCRIPTION

The SA3603 is an integrated Low-Noise Amplifier (LNA) and mixer designed in a 30 GHz $\rm f_T$ advanced BICMOS process, Qubic3, for high-performance low power Cellular-band communication systems. The LNA has a 1.6 dB noise figure at 881 MHz with 17.5 dB gain and an IIP3 intercept of -4 dBm. The single-ended input, single balanced mixer has a 9.5 dB noise figure with 7.5 dB gain and IIP3 of +6.0 dBm at 881 MHz.

FEATURES

- Integrated LNA output matching
- Excellent gain stability versus temperature and supply voltage
- LNA, mixer and LO buffer power down capability

APPLICATIONS

- IS-136 Standard systems
- Wireless radios

PIN CONFIGURATION

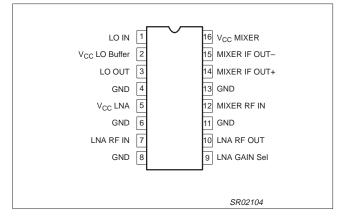


Figure 1. Pin Configuration

ORDERING INFORMATION

DESCRIPTION	TEMPERATURE RANGE	ORDER CODE	DWG #	
16-Pin Thin Shrink Small Outline Package (Sur	face-mount, TSSOP)	−40 to +85°C	SA3603 DH	

Cellular-band low voltage front-end

SA3603

PINOUT DEFINITION

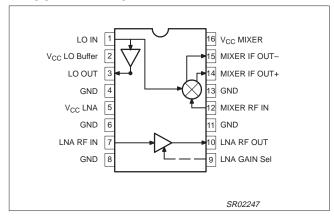


Figure 2. Pinout definition

PIN DESCRIPTION

PIN NUMBER	SYMBOL	FUNCTION
1	LO_IN	VCO input
2	VCC LO BUFFER	LO buffer supply voltage
3	LO OUT	VCO output
4, 6, 8, 11, 13	GND	Ground
5	VCC LNA	LNA supply voltage
7	LNA RF IN	LNA input
9	LNA GAIN SEL	LNA gain select
10	LNA RF OUT	LNA output
12	MIXER RF IN	Mixer input
14	MIXER IF OUT+	Mixer output +
15	MIXER IF OUT-	Mixer output –
16	VCC MIXER	Mixer supply voltage

1999 Dec 17

Cellular-band low voltage front-end

SA3603

ABSOLUTE MAXIMUM RATINGS

SYMBOL	PARAMETER	RATING	UNITS
V _{CC}	Supply voltage ¹	-0.3 to +3.5	V
V _{IN}	Voltage applied to any other pin	-0.3 to (V _{CC} + 0.3)	V
P _D	Power dissipation, T _{amb} = 25°C (still air) ² 16-Pin Plastic TSSOP	TBD	mW
T _{JMAX}	Maximum operating junction temperature	150	°C
P _{MAX}	Maximum power input/output	+20	dBm
T _{STG}	Storage temperature range	-65 to +150	°C

NOTES:

- Transients exceeding 3.6 V on V_{CC} pin may damage product.
 Maximum dissipation is determined by the operating ambient temperature and the thermal resistance, θ_{JA}: 16-Pin TSSOP = TBD°C/W
 Pins 14 and 15 are ESD sensitive (mixer outputs).

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	RATING	UNITS
V _{CC}	Supply voltage	2.7 to 3.3	V
T _{amb}	Operating ambient temperature range	-40 to +85	°C

DC ELECTRICAL CHARACTERISTICS

 V_{CC} = +2.8 V, T_{amb} = 25°C; unless otherwise stated.

SYMBOL	PARAMETER	TEST CONDITIONS		UNITS			
STWIBOL	FARAINETER	TEST CONDITIONS	MIN	TYP	MAX	014110	
		LO buffer		6		mA	
I _{CC}	Supply current	LNA high gain		6		mA	
		Mixer		12		mA	
V _{IH}	Logic 1 level		2.0		V _{CC} + 0.3	V	
V _{IL}	Logic 0 level		-0.3		0.5	V	
I _{BIAS}	Input bias current	Logic 1 or 0	- 5		+5	μА	

1999 Dec 17

Cellular-band low voltage front-end

SA3603

AC ELECTRICAL CHARACTERISTICS

 V_{CC} = +2.8 V; f_{RF} = 881 MHz, f_{VCO} = 991 MHz; T_{amb} = 25°C; unless otherwise stated.

SYMBOL	DADAMETED	TEST CONDITIONS	LIMITS					
SYMBOL	PARAMETER	TEST CONDITIONS	MIN.	- 3 σ TYP +3 σ !			MAX.	UNITS
Overall Sys	tem							
G _{SYS}	System gain	LNA + Mixer (excluding filter loss)	22					dB
Low Noise	Amplifier					_	_	
f_{RF}	RF input frequency range		869				894	MHz
S ₂₁	Gain				17.5			dB
S ₂₁	Gain in power-down mode				2			dB
S ₁₂	Reverse isolation	@ 881 MHz			TBD			dB
S ₁₁	Input return loss	50 Ω system			10			dB
S ₂₂	Output return loss	50 Ω system			10			dB
P _{-1dB}	Input 1 dB gain compression				-19			dBm
IIP3	Input third order intercept	P _{RFin} = -35 dBm, 60 kHz offset			-4			dBm
NF	Noise figure				1.6			dB
t _{ON/OFF}	Turn on/off time ¹						100	μs
Mixer							•	
f _{RF}	RF input frequency range		869				894	MHz
f _{IF}	IF input frequency range		70		110		200	MHz
PG _C	Power conversion gain	f _{IF} = 110 MHz			7.5			dB
S _{11M}	Input match	Ext. impedance matching req.			-10			dB
NF _M	SSB noise figure				9.5			dB
P _{-1dB}	Input 1 dB gain compression				-15			dBm
IIP3 _M	Input third order intercept	P _{RFin} = -27 dBm, 60 kHz offset			6			dBm
IIP _{2INT}	Input second order intercept				26			dBm
P _{RFM-IF}	RF feedthrough	P _{RFin} = -35 dBm			TBD			dBm
t _{ON/OFF}	Turn on/off time ¹						100	μs
LO Buffer					•	•		
f _{LO}	Input frequency range		939				1094	MHz
P _{IN}	Input power		-2		0		+2	dBm
P _{OUT}	Output power				0			dBm
S ₁₁	Input return loss	50 Ω system			10			dB
S ₂₂	Output return loss	50 Ω system			10			dB
P _{LO-IF}	LO feedthrough to IF				TBD			dBm
P _{LO-RFM}	LO to mixer input feedthrough				TBD	İ		dBm
P _{LO-RF}	LO to LNA input feedthrough				TBD			dBm
	Harmonic content				-20			dB
t _{ON/OFF}	Turn on/off time ¹						100	μs

NOTE:

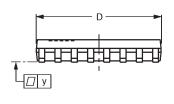
^{1.} External circuit dependent

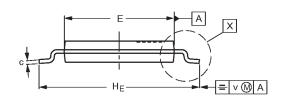
Cellular-band low voltage front-end

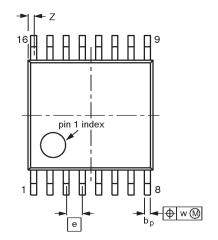
SA3603

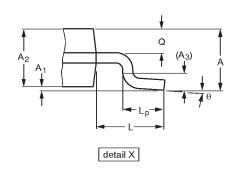
TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

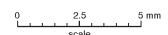
SOT403-1











DIMENSIONS (mm are the original dimensions)

UNIT	A max.	Α1	A ₂	А3	bp	С	D ⁽¹⁾	E ⁽²⁾	е	HE	L	Lp	Ø	v	w	у	Z ⁽¹⁾	θ
mm	1.10	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1.0	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.40 0.06	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE
SOT403-1		MO-153			-94-07-12 95-04-04

Cellular-band low voltage front-end

SA3603

NOTES

Cellular-band low voltage front-end

SA3603

Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

^[1] Please consult the most recently issued datasheet before initiating or completing a design.

Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information — Applications that are described herein for any of these products are for illustrative purposes only. Philips Semiconductors make no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Disclaimers

Life support — These products are not designed for use in life support appliances, devices or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips Semiconductors customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips Semiconductors for any damages resulting from such application.

Right to make changes — Philips Semiconductors reserves the right to make changes, without notice, in the products, including circuits, standard cells, and/or software, described or contained herein in order to improve design and/or performance. Philips Semiconductors assumes no responsibility or liability for the use of any of these products, conveys no license or title under any patent, copyright, or mask work right to these products, and makes no representations or warranties that these products are free from patent, copyright, or mask work right infringement, unless otherwise specified.

Philips Semiconductors 811 East Arques Avenue P.O. Box 3409 Sunnyvale, California 94088–3409 Telephone 800-234-7381 © Copyright Philips Electronics North America Corporation 2000 All rights reserved. Printed in U.S.A.

Date of release: 04-00

Document order number: 9397 750 07035

Let's make things better.

Philips Semiconductors



